NOTICE OF EDITORIAL CORRECTIONS

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Notice of Editorial Corrections (NOEC)

The purpose of this document is to provide users of the Cooperative Patent Classification (CPC) scheme notice of minor, non-content-related edits that were made to improve the format, grammar and punctuation of the CPC scheme. Types of edits may include the following: adding or removing periods or commas; removing extraneous information from images, e.g. patent numbers; or correcting spelling errors.

Editorial Corrections from project EC12489

Area	Current text	Proposed edit
Scheme		-
A23B 4/0053	Note 1. The heating means for the gas or liquid are not classified	Note 1. {The heating means for the gas or liquid are not classified.}
A61K41/0023	. {Agression treatment or altering}	. {Aggression treatment or altering}
A61K41/0023	NOTE This groups covers a ggression treatment or altering of a medicinal preparation prior to administration to the human/animal, e.g. altering a binding specificity of a monoclonal antibody used in a medicinal a gent with an oxidizing a gent or an electric potential; of a tissue/organ prior to graft, e.g. destroying immunodominant epitopes; the permeability of cell membranes or biological barriers in vivo, e.g. by ultrasound, prior to the administration of a medicinal preparation to the animal/human; for inducing the production of stress response proteins or heat shock proteins in order to reduce subsequent response to injuries	NOTE This group covers a ggression treatment or altering of a medicinal preparation prior to administration to the human/animal, e.g. altering a binding specificity of a monoclonal antibody used in a medicinal a gent with a noxidizing a gent or an electric potential; of a tissue/organ prior to graft, e.g. destroying immunodominant epitopes; the permeability of cell membranes or biological barriers in vivo, e.g. by ultrasound, prior to the administration of a medicinal preparation to the animal/human; for inducing the production of stress response proteins or heat shock proteins in order to reduce subsequent response to injuries}

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Area	Current text	Proposed edit
A61K41/0047	Note	Note
	1. To be classified in A61K 9/0009 when it is in relation to the galenic form	1. {To be classified in A61K9/0009 when it is in relation to the galenic form.}
A61K49/005	Note	Note
	Classification is also made according to the nature of the fluorescent group in the appropriate subgroup of <u>A61K49/0019</u>	{Classification is a lso made according to the nature of the fluorescent group in the appropriate subgroup of A61K49/0019.}
A61K49/006	Note	Note
	If the dye used for staining is fluorescent, classification is also given for the appropriate subgroup of <u>A61K</u> 49/0019	{If the dye used for staining is fluorescent, classification is a lso given for the appropriate subgroup of A61K49/0019.}
A61K49/0063	Note	Note
	Note Classification is also made according to the nature of the luminescent or fluorescent agent and/or the carrier carrying the fluorescent agent	{Note Classification is also made according to the nature of the luminescent or fluorescent a gent and/or the carrier carrying the fluorescent agent.}
A61K49/0067	Note	Note
	Quantum dots modified on their surface by an antibody are also classified in <u>A61K49/0058</u>)	{Quantum dots modified on their surface by an antibody are also classified in A61K 49/0058.}
A61K49/0069	Note	Note
	1. If the physical or galenical form containing a fluorescent agent is modified by a particular agent, classification is also made according to the nature of this agent in the appropriate A61K49/005 subgroup	{If the physical or galenical form containing a fluorescent a gent is modified by a particular a gent, classification is a lso made according to the nature of this a gent in the appropriate A61K 49/005 subgroup.}
A61K49/0078	1. Microemulsion means that the dispersed phase is in the form of globules having a diameter above or equal to 1 micrometer. Nanoemulsion means that the dispersed phase is in the form of	1. {Microemulsion means that the dispersed phase is in the form of globules having a diameter above or equal to 1 micrometer. Nanoemulsion means that the dispersed phase is in the form of globules having a diameter below 1 micrometer.}

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	globules ha ving a diameter below 1 micrometer	
A61K49/0082	Note	Note
	1. Micelles comprise a monolayer of surfactant molecules that are a ggregated head-to-head and tail-to-tail, thus forming a small spherical particle; micelles can be normal, i.e., the surfactant heads are hydrophilic, or inverse	1. {Micelles comprise a monolayer of surfactant molecules that are a ggregated head-to-head and tail-to-tail, thus forming a small spherical particle; micelles can be normal, i.e., the surfactant heads are hydrophilic, or inverse.}
A61K49/0084	Note	Note
	1. When the surface of the liposome encapsulating a fluorescent a gent and used in vivo is functionalised by a modifying a gent, classification is also made according to the nature of this modifying a gent: e.g. a liposome modified on its surface by a peptide is classified in A61K 49/0084 and A61K 49/0056. Liposomes encapsulating a fluorescent agent, used in vivo and modified on their surface by a polymer because they incorporate a polymer-lipid conjugate, are only additionally classified in A61K 49/0054 if the polymer modifying the lipid is unusual. Liposomes encapsulating a fluorescent a gent which are pegylated because they incorporate a pegylated because they incorporate a pegylated lipid are only classified in A61K 49/0084, not in A61K 49/0054	1. {When the surface of the liposome encapsulating a fluorescent a gent and used in vivo is functionalised by a modifying a gent, classification is also made according to the nature of this modifying a gent: e.g. a liposome modified on its surface by a peptide is classified in A61K 49/0084 and A61K 49/0056. Liposomes encapsulating a fluorescent a gent, used in vivo and modified on their surface by a polymer because they incorporate a polymer-lipid conjugate, are only additionally classified in A61K 49/0054 if the polymer modifying the lipid is unusual. Liposomes encapsulating a fluorescent agent which are pegylated because they incorporate a pegylated lipid are only classified in A61K 49/0084, not in A61K 49/0054.}
A61K49/0091	Note	Note
	1. When the surface of the microparticle encapsulating a fluorescent a gent and used in vivo is functionalised by a modifying a gent, classification is a lso made according to the nature of this modifying a gent, e.g. a microparticle modified on its surface by a peptide is classified in A61K49/0091 and A61K49/0056	1. {When the surface of the microparticle encapsulating a fluorescent a gent and used in vivo is functionalised by a modifying agent, classification is also made according to the nature of this modifying agent, e.g. a microparticle modified on its surface by a peptide is classified in A61K 49/0091 and A61K 49/0056.}

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Area	Current text	Proposed edit
A61K49/085	Note	Note
	1. The MRI-active nucleus being complexed to a complex-forming compound (e.g. chelating group) or being covalently linked to a molecule, which being further covalently linked or conjugated to a carrier, e.g. polymer. Classification being also made according to the nature of the carrier, e.g. [Gd3+]DOTA-polymer to be classified in A61K49/085 and in the appropriate A61K49/12 a dequate subgroup	1. {The MRI-active nucleus being complexed to a complex-forming compound (e.g. chelating group) or being covalently linked to a molecule, which being further covalently linked or conjugated to a carrier, e.g. polymer. Classification being also made a ccording to the nature of the carrier, e.g. [Gd3+]DOTA-polymer to be classified in A61K49/085 and in the appropriate A61K49/12 adequate subgroup.}
A61K49/101	Note	Note
	1. In the A61K 49/101 subgroups, the MRI-active nucleus being complexed to a complex-forming compound, e.g. chelating group. Classification being made according to the nature of this complex-forming a gent, if it being either an uncommonor new complexing agent (not the usual DTPA, DOTA, DOTP, etcgroups) that forms the real contribution to the claimed MRI invention, or if it being not conjugated to any further molecule, e.g. which being not conjugated to a polymer, peptide, protein or antibody. In that latter case, the MRI probe being e.g. a paramagnetic metal chelate	1. {In the A61K 49/101 subgroups, the MRIactive nucleus being complexed to a complex-forming compound, e.g. chelating group. Classification being made according to the nature of this complexforming agent, if it being either an uncommonor new complexing agent (not the usual DTPA, DOTA, DOTP, etcgroups) that forms the real contribution to the claimed MRI invention, or if it being not conjugated to any further molecule, e.g. which being not conjugated to a polymer, peptide, protein or antibody. In that latter case, the MRI probe being e.g. a paramagnetic metal chelate.}
A61K49/124	Note	Note
	1. Said compounds are either complexes or complex-forming compounds, or they form a backbone to which MRI active nuclei are complexed or covalently linked through chelating groups. In that latter case, the subgroup A61K 49/085 being a lso given. Dendrimeric, dendronised or hyperbranched polyamino acids used as carriers are a ko classified in A61K 49/146	1. {Said compounds are either complexes or complex-forming compounds, or they form a backbone to which MRI active nuclei are complexed or covalently linked through chelating groups. In that latter case, the subgroup A61K 49/085 being also given. Dendrimeric, dendronised or hyperbranched polyamino acids used as carriers are also classified in A61K 49/146.}

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A61K49/128	Note	Note
	1. In that latter case, classification is also made in <u>A61K49/085</u>	1. {In that latter case, classification is also made in A61K49/085.}
A61K49/1812	Note	Note
	1. If the paramagnetic metal complexes are covalently linked to the bila yered membrane, then the A61K 49/085 subgroup being a lso given. Liposomes modified on their external surface by a targeting a gent, e.g. an antibody are classified in A61K 49/1812 without further indication for the targeting agent	1. {If the paramagnetic metal complexes are covalently linked to the bila yered membrane, then the A61K 49/085 subgroup being a lso given. Liposomes modified on their external surface by a targeting a gent, e.g. an antibody are classified in A61K 49/1812 without further indication for the targeting a gent.}
A61K49/1818	Note	Note
	For nanoparticles, i.e. having a size or diameter smaller than 1 micrometer, the subgroups <u>B82Y 5/00</u> and <u>B82Y</u> <u>15/00</u> are also given	1. {For nanoparticles, i.e. having a size or diameter smaller than 1 micrometer, the subgroups <u>B82Y 5/00</u> and <u>B82Y 15/00</u> are also given.}
A61K51/041	Note	Note
	Under this group, the last place rule is followed	1. {Under this group, the last place rule is followed.}
A61K51/0451	Note	Note
	Porphyrins or texaphyrins used as complex-forming compounds, i.e. wherein the nitrogen atoms forming the central ring system complex the radioactive metal, are classified in A61K 51/0485	{Porphyrins or texaphyrins used as complex-forming compounds, i.e. wherein the nitrogen atoms forming the central ring system complex the radioactive metal, are classified in A61K51/0485 .}
A61K51/0474	Note	Note
	1. Classification is made according to the nature of this complex-forming a gent, if it is either an uncommon or new complexing a gent (not the usual DTPA, DOTA, DOTP, MAG3 etcgroups) that forms the real contribution to the claimed invention (radioimaging or radiotherapeutic a gent), or if it is not	1. {Classification is made according to the nature of this complex-forming a gent, if it is either an uncommon or new complexing a gent (not the usual DTPA, DOTA, DOTP, MAG3 etcgroups) that forms the real contribution to the claimed invention (radioimaging or radiotherapeutic agent), or if it is not conjugated to any further

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Area	Current text	Proposed edit
	conjugated to any further molecule, e.g. which is not conjugated to a polymer, peptide, protein or a ntibody. In that latter case, the radioactive agent is e.g. a radioactive metal chelate	molecule, e.g. which is not conjugated to a polymer, peptide, protein or antibody. In that latter case, the radioactive a gent is e.g. a radioactive metal chelate.}
A61K51/0485	Note	Note
	Porphyrins used as simple heterocyclic carriers containing a radioactive nucleus (e.g. 11C) or substituted with a radioactive nucleus (e.g. 18F), are classified in A61K 51/0451	1. {Porphyrins used as simple heterocyclic carriers containing a radioactive nucleus (e.g. 11C) or substituted with a radioactive nucleus (e.g. 18F), are classified in A61K 51/0451.}
A61K51/0495	Note	Note
	1. Pretargeting is the administration of an agent X bearing the radioisotope or radioactive nucleus and of an agent Y capable of binding X and a cell Y in several steps, e.g. the radiolabelled agent is a radiolabelled biotin and the agent Y is a (strept)a vidin molecule targeting specific cells. Classification is a ko made according to the nature of the carrier bearing/linked to the radioactive nucleus, e.g. an antibody	1. {Pretargeting is the administration of an a gent X bearing the radioisotope or radioactive nucleus and of an agent Y capable of binding X and a cell Y in several steps, e.g. the radiolabelled agent is a radiolabelled biotin and the agent Y is a (strept) a vidin molecule targeting specific cells. Classification is a lso made according to the nature of the carrier bearing/linked to the radioactive nucleus, e.g. an antibody.}
A61K51/0497	Note	Note
	1. The compound which bears, complexes or chelates the radioactive nucleus, is covalently linked or complexed to the carrier being another (small) organic molecule, i.e. not oligomeric, polymeric, dendrimeric. Classification is also made according to the nature of this small organic molecule. In case of a conjugate comprising a complex-forming compound (chelating group) complexing a radioactive metal linked to the carrier (organic compound in A61K 51/0497), the nature of this complex-forming compound is not classified except if the complexing/chelating group is the subject of the invention and is uncommon, e.g. 111In-DTPA-glucose is	1. {The compound which bears, complexes or chelates the radioactive nucleus, is covalently linked or complexed to the carrier being another (small) organic molecule, i.e. not oligomeric, polymeric, dendrimeric. Classification is also made according to the nature of this small organic molecule. In case of a conjugate comprising a complex-forming compound (chelating group) complexing a radioactive metal linked to the carrier (organic compound in A61K 51/0497), the nature of this complex-forming compound is not classified except if the complexing/chelating group is the subject of the invention and is uncommon, e.g. 111In-DTPA-glucose is classified in A61K

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	classified in A61K51/0497 (not	51/0497 (notin $A61K51/048$) and
	in <u>A61K51/048</u>) and in <u>A61K51/0491</u>	in <u>A61K51/0491.</u> }
A61K51/065	NOTE	Note
A01K31/003	NOTE	Note
	• The compound which bears, complexes or chelates the radioactive nucleus, is covalently linked or complexed to the carrier being a macromolecule (not being a peptide, polyamino acid, protein, antibody). In case of a conjugate comprising a complex-forming compound (chelating group) complexing a radioactive metal linked to the carrier (organic macromolecular compound in A61K 51/065), the nature of this complex-forming compound is not classified except if it is the real contribution of the claimed invention and it is an uncommon complexing/chelating group, e.g. 111In-DTPA-PEG is classified in A61K 51/065 and new DTPA-like derivatives conjugated to PEG and complexing 111In for use in vivo is classified in A61K 51/0478 and A61K 51/065	• {The compound which bears, complexes or chelates the radioactive nucleus, is covalently linked or complexed to the carrier being a macromolecule (not being a peptide, polyamino acid, protein, antibody). In case of a conjugate comprising a complex-forming compound (chelating group) complexing a radioactive metal linked to the carrier (organic macromolecular compound in A61K 51/065), the nature of this complex-forming compound is not classified except if it is the real contribution of the claimed invention and it is an uncommon complexing/chelating group, e.g. 111In-DTPA-PEG is classified in A61K 51/065 and new DTPA-like derivatives conjugated to PEG and complexing 11 IIn for use in vivo is classified in A61K 51/0478 and A61K 51/065.}
A61K51/088	Note	Note
	1. The compound which bears, complexes or chelates the radioactive nucleus, is covalently linked/complexed to the carrier being a peptide, polyamino acid or protein (not being an antibody). Classification is also made according to the nature of the peptide or protein (e.g. if it is BSA, then A61K51/081 is also indicated). In case of a conjugate comprising a complex-forming compound (chelating group) complexing a radioactive metal linked to the carrier (peptide, protein or polyamino acid in A61K51/088), the nature of this complex-forming compound is not classified except if it is the real contribution of the claimed invention and it is an uncommon complexing or	1. {The compound which bears, complexes or chelates the radioactive nucleus, is covalently linked/complexed to the carrier being a peptide, polyamino acid or protein (not being an antibody). Classification is also made according to the nature of the peptide or protein (e.g. if it is BSA, then A61K51/081 is also indicated). In case of a conjugate comprising a complexforming compound (chelating group) complexing a radioactive metal linked to the carrier (peptide, protein or polyamino acid in A61K51/088), the nature of this complex-forming compound is not classified except if it is the real contribution of the claimed invention and it is an uncommon complexing or chelating group, e.g. 111In-DTPA-

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	chelating group, e.g. 111In-DTPA- interleukin 2 is classified in <u>A61K</u> 51/088; new DTPA-like derivatives conjugated to interleukin 2 and complexing 11 IIn for use in vivo is classified in <u>A61K 51/0478</u> and <u>A61K</u> 51/088	interleukin 2 is classified in A61K51/088; new DTPA-like derivatives conjugated to interleukin 2 and complexing 111 In for use in vivo is classified in A61K51/0478 and A61K51/088.}
A61K51/1093	Note	Note
	1. The compound which bears, complexes or chelates the radioactive nucleus, being covalently linked or complexed to the carrier being an antibody. Classification being also made according to the appropriate A61K 51/10 subgroup. In case of a conjugate comprising a complex-forming compound (chelating group) complexing a radioactive metal linked to the carrier (antibody in A61K 51/1093), the nature of this complex-forming compound being not classified except if it being the real contribution of the claimed invention and it being an uncommon complexing/chelating group, e.g. 111In-DTPA-herceptin being classified in A61K 51/1093 and A61K 51/1051, new DTPA-like derivatives conjugated to herceptin and complexing 111 In for use in vivo being classified in A61K 51/1051	1. {The compound which bears, complexes or chelates the radioactive nucleus, being covalently linked or complexed to the carrier being an antibody. Classification being also made according to the appropriate A61K51/10 subgroup. In case of a conjugate comprising a complexforming compound (chelating group) complexing a radioactive metal linked to the carrier (antibody in A61K51/1093), the nature of this complex-forming compound being not classified except if it being the real contribution of the claimed invention and it being an uncommon complexing/chelating group, e.g. 111In-DTPA-herceptin being classified in A61K51/1093 and A61K51/1051, new DTPA-like derivatives conjugated to herceptin and complexing 111In for use in vivo being classified in A61K51/1093 and A61K51/1093 and A61K51/1093.
A61K51/1234	Note	Note
	Liposomes modified on their external surface by a targeting a gent, e.g. an antibody, are not a dditionally classified with the symbol of the targeting a gent	1. {Liposomes modified on their external surface by a targeting a gent, e.g. an antibody, are not a dditionally classified with the symbol of the targeting a gent.}
B01D29/668	Note	Note
	the subgroup covers only counter- current flushing	{the subgroup covers only counter-current flushing.}

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B01D53/1493	Note	Note
	1. In <u>B01D53/1493</u> it is desirable to add indexing codes for compositional aspects of absorbents. The codes are chosen from <u>B01D2252/00</u> - <u>B01D</u> 2252/61	1. {In B01D53/1493 it is desirable to add indexing codes for compositional a spects of absorbents. The codes are chosen from B01D2252/00 - B01D2252/61.}
B01J20/0203	Note	Note
	Compounds classified in group B01J 20/0203 and subgroups are also classified in B01J20/0274 according to the type of anion	1. {Compounds classified in group B01J 20/0203 and subgroups are also classified in B01J 20/0274 according to the type of anion.}
B01J23/002	Note	Note
	1. In group B01J23/002, elements constituting the exemplified mixed oxide are further indexed under the form of a C-set with B01J2523/00 as base symbol using the relevant classification symbols of B01J2523/10 - B01J2523/847, in numerical order, as further symbols and separated by ",", e.g. the mixed oxide MoaVbTecOx is classified as (B01J2523/00, B01J2523/55, B01J2523/64, B01J2523/68).	1. {In group B01J23/002, elements constituting the exemplified mixed oxide are further indexed under the form of a C-set with B01J2523/00 as base symbol using the relevant classification symbols of B01J2523/10 - B01J2523/847, in numerical order, as further symbols and separated by ",", e.g. the mixed oxide MoaVbTecOx is classified as (B01J2523/00, B01J2523/55, B01J2523/64, B01J2523/68).}
B01J31/003	Note	Note
	In this group, the presence of water is disregarded for classification purposes	{In this group, the presence of water is disregarded for classification purposes.}
B05D7/50	Note	Note
	A possible inorganic pretreatment or coating on the substrate such as chromatation, phosphatation, plating, is not counted as a layer. This group covers mostly multilayers characterised by each layer and the succession of them (la minates in general B32B)	1. {A possible inorganic pretreatment or coating on the substrate such as chromatation, phosphatation, plating, is not counted as a layer. This group covers mostly multilayers characterised by each layer and the succession of them (la minates in general B32B).}
B23D36/0091	Note	Note

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Area	Current text	Proposed edit
	1. Broaching	1. {Broaching}
B29C 33/0033	Note	Note
	1. If the hole is made by cutting means a ssociated with the mould, see the relevant moulding technique	1. {If the hole is made by cutting means a ssociated with the mould, see the relevant moulding technique.}
B29C 45/0001	Note	Note
	1. When classifying in this group, it is desirable to add the indexing codes of subclass B29K to identify the moulding materials and their properties. Documents concerning the choice of moulding materials having a particular influence on the moulding technique should be classified in this group if of interest	1. {When classifying in this group, it is desirable to add the indexing codes of subclass B29K to identify the moulding materials and their properties. Documents concerning the choice of moulding materials having a particular influence on the moulding technique should be classified in this group if of interest.}
B29C51/002	When classifying in this group, it is desirable to add the indexing codes of subclass B29K to identify the moulding materials and their properties. Documents concerning the choice of moulding materials having a particular influence on the moulding technique should be classified in this group if of interest	{When classifying in this group, it is desirable to add the indexing codes of subclass B29K to identify the moulding materials and their properties. Documents concerning the choice of moulding materials having a particular influence on the moulding technique should be classified in this group if of interest.}
B29C 53/005	When classifying in this group, it is desirable to add the indexing codes of subclass B29K to identify the moulding materials and their properties. Documents concerning the choice of moulding materials having a particular influence on the moulding technique should be classified in this group if of interest	{When classifying in this group, it is desirable to add the indexing codes of subclass B29K to identify the moulding materials and their properties. Documents concerning the choice of moulding materials having a particular influence on the moulding technique should be classified in this group if of interest.}
B29C 55/005	When classifying in this group, it is desirable to add the indexing codes of subclass B29K to identify the moulding materials and their properties. Documents concerning the choice of moulding materials having a particular influence on the moulding technique should be classified in this group if of interest	{When classifying in this group, it is desirable to add the indexing codes of subclass B29K to identify the moulding materials and their properties. Documents concerning the choice of moulding materials having a particular influence on the moulding technique should be classified in this group if of interest.}
B29C 59/005	Documents in which moulding materials are mentioned are indexed using indexing codes of subclass B29K. However, when, for example, documents concerning the choice of moulding material having a particular influence on the moulding technique cannot be satisfactorily indexed, the documents may be classified in this group if of interest	{Documents in which moulding materials are mentioned are indexed using indexing codes of subclass B29K. However, when, for example, documents concerning the choice of moulding material having a particular influence on the moulding technique cannot be satisfactorily indexed, the documents may be classified in this group if of interest.}

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B29C 61/003	When classifying in this group, it is desirable	{When classifying in this group, it is desirable
	to add the indexing codes of subclass B29K	to add the indexing codes of subclass B29K to
	to identify the moulding materials and their	identify the moulding materials and their
	properties. Documents concerning the choice	properties. Documents concerning the choice
	of moulding materials having a particular	of moulding materials having a particular
	influence on the moulding technique should	influence on the moulding technique should be
	be classified in this group if of interest	classified in this group if of interest.}
B29C 63/0017	When classifying in this group, it is desirable	{When classifying in this group, it is desirable
	to add the indexing codes of subclass B29K	to add the indexing codes of subclass B29K to
	to identify the moulding materials and their	identify the moulding materials and their
	properties. Documents concerning the choice	properties. Documents concerning the choice
	of moulding materials having a particular	of moulding materials having a particular
	influence on the moulding technique should	influence on the moulding technique should be
	be classified in this group if of interest	classified in this group if of interest.}
B29C 65/645	When classifying in this group, compositions	{When classifying in this group, compositions
	of the non-plastics element are additionally	of the non-plastics element are additionally
	classified in the relevant groups, i.e. in B29C	classified in the relevant groups, i.e. in B29C
D20D 11/00E2	66/74 and subgroups	66/74 and subgroups.}
B29D11/0073	Classification in this group must be	{Classification in this group must be
	supplemented, in so far as any product is	supplemented, in so far as any product is
G01D 2/0026	concerned, by classification in B32B	concerned, by classification in B32B.}
C01B 3/0026	1. In all of the groups C01B 3/0026-C01B	{1. In all of the groups C01B 3/0026-C01B
	3/0084, the metallic storage materials	3/0084, the metallic storage materials may
	may contain minor quantities of non-	contain minor quantities of non-metals such as
	metals such as B, C, O, S, Se, Si; e.g.	B, C, O, S, Se, Si; e.g. C01B 3/0036 "only containing iron and titanium" includes Fe-Ti
	C01B 3/0036 "only containing iron and titanium" includes Fe-Ti compositions	_
	comprising non-metals	compositions comprising non-metals.} {2. In the groups C01B 3/0026 and C01B
	2. In the groups C01B 3/0026 and C01B	3/0047 - C01B 3/0068 a "rare-earth metal"
	3/0047 - C01B 3/0068 a "rare-earth	means one single metal or a combination of
	metal" means one single metal or a	metals selected from the lanthanides, Sc or Y.
	combination of metals selected from the	include sciented from the landingers, see of 1.5
	lanthanides, Sc or Y	
C01B 13/0229	In groups C01B 13/0229 - C01B 13/0288,	{In groups C01B 13/0229 - C01B 13/0288,
	additional features relating to the purification	additional features relating to the purification
	or separation processes are indexed with	or separation processes are indexed with codes
	codes chosen from C01B 2210/0026 - C01B	chosen from C01B 2210/0026 - C01B
	2210/0098.	2210/0098.}
C01B 13/0288	In this group, processing steps are indexed	{In this group, processing steps are indexed
	with codes chosen from C01B 2210/0001 -	with codes chosen from C01B2210/0001 -
	C01B 2210/0025	C01B 2210/0025.}
C01B 21/0405	In this group, additional features relating to	{In this group, additional features relating to
	the purification or separation processes are	the purification or separation processes are
	indexed with codes chosen from C01B	indexed with codes chosen from C01B
	2210/0026 - C01B 2210/0098	2210/0026 - C01B 2210/0098.}
C01B 21/0494	In this group, processing steps are indexed	{In this group, processing steps are indexed
	with codes chosen from C01B 2210/0001 -	with codes chosen from C01B 2210/0001 -
	C01B 2210/0025	C01B 2210/0025.}

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C01B 23/0094	In this group, processing steps are indexed	{In this group, processing steps are indexed
	with codes chosen from C01B 2210/0001 -	with codes chosen from C01B 2210/0001 -
	C01B 2210/0025	C01B 2210/0025.}
C01B 25/461	1. The extracting a gent may be diluted with	{1. The extracting a gent may be diluted with a
	a compound or a mixture of compounds	compound or a mixture of compounds which
	which are not solvents for phosphoric	are not solvents for phosphoric acid, e.g. a
	acid, e.g. a hydrocarbon	hydrocarbon.}
	2. Documents which belong to more than	{2. Documents which belong to more than one
	one subgroup of C01B 25/462 - C01B	subgroup of C01B 25/462 - C01B 25/466 are
	25/466 are classified by a combination,	classified by a combination, e.g. C01B 25/462
	e.g. C01B 25/462+B4+B8	+B4+B8.}
C01B 33/325	In this group, obtaining solid silicate, e.g. as	{In this group, obtaining solid silicate, e.g. as a
	a hydrate of a crystalline silicate, from a	hydrate of a crystalline silicate, from a solution
	solution or a hydrate melt by heating or	or a hydrate melt by heating or cooling with or
	cooling with or without seeding, is not	without seeding, is not considered as a fter-
	considered as after-treatment, but classified	treatment, but classified in group C01B 33/32.}
	in group C01B 33/32	
C02F 1/46109	When classifying in group C02F 1/46109,	{When classifying in group C02F 1/46109,
	details of devices for electrolysis can be	details of devices for electrolysis can be further
	further indexed by using indexing codes	indexed by using indexing codes chosen from
	chosen from C02F 2001/46119 - C02F	C02F2001/46119 - C02F2001/46166.}
	2001/46166	
C02F 1/4618	When classifying in group C02F 1/4618,	{When classifying in group C02F 1/4618,
	details relating to the production of "ionised"	details relating to the production of "ionised"
	acidic or basic water using electrolysis	acidic or basic water using electrolysis devices
	devices can be further indexed by using	can be further indexed by using indexing codes
	indexing codes chosen from C02F	chosen from C02F 2001/46185 - C02F
	2001/46185 - C02F2001/46195	2001/46195.}
C03B 35/185	Disc rollers having a discontinuous surface	{Disc rollers having a discontinuous surface
	are also classified in C03B 35/189	are also classified in C03B 35/189.}
C03B 35/189	Disc rollers having a discontinuous surface	{Disc rollers having a discontinuous surface
	are also classified in C03B 35/185	are also classified in C03B 35/185.}
C0.4D	T (1) (1 C 11 '	
C04B	In this group the following term is used with	{In this group the following term is used with
35/63472	the meaning indicated:	the meaning indicated:
	• "aldehydes" also covers other	"aldehydes" also covers other organic
	organic compounds reacting as	compounds reacting as aldehydes, e.g.
C04B 38/0067	aldehydes, e.g. glyoxylic acid	glyoxylic acid.}
CU4B 38/UU6/	This group is mainly used for classification	{This group is mainly used for classification
	using Combination Sets in C04B 38/00	using C-Sets in C04B 38/00.}
C04B 38/007	This group is mainly used for classification	{This group is mainly used for classification
CU4D 30/UU/	• .	using C-Sets in C04B 38/00.}
	using Combination Sets in C04B 38/00	using C-3618 iii C04D 38/00.}
C04B 38/065	Documents having this group as	{Documents having this group as classification
C07D 30/003	classification symbol or as part of a	symbol or as part of a C-Set can also get
	Combination Set can also get symbol C04B	symbol C04B 38/0051 in the C-Set, if the
	38/0051 in the Combination Set, if the	importance of the size of the pores obtained is
	importance of the size of the pores obtained	emphasized.}
	is emphasized.	empiasized. J
	is emphasized.	

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Area	Current text	Proposed edit
C04B 38/066	Documents having this group as	{Documents having this group as classification
	classification symbol or as part of a	symbol or as part of a C-Set can also get
	Combination Set can also get symbol C04B	symbol C04B 38/007 in the C-Set, if the
	38/007 in the Combination Set, if the	importance of the distribution of the pores is
	importance of the distribution of the pores is	emphasized.}
	emphasized.	_
C04B 41/0009	Products classified in group C04B 41/0009	{Products classified in group C04B 41/0009
	should also be classified according to their	should also be classified according to their
	composition, e.g. in C04B 28/00	composition, e.g. in C04B 28/00.}
C04B 41/0063	In this group the term "cooling" is used in the	{In this group the term "cooling" is used in the
	sense of an additional cooling treatment,	sense of an additional cooling treatment,
	different from the traditional cooling step in	different from the traditional cooling step in the
	the fabrication of materials involving a	fabrication of materials involving a heating
	heating step, such as sintering of ceramics	step, such as sintering of ceramics.}
C04B 41/4523	Coating or impregnating with a specific	{Coating or impregnating with a specific
	material in the molten state is classified	material in the molten state is classified
	according to the specific material and get	according to the specific material and get
	symbol C04B 41/4523 in Combination Sets	symbol C04B 41/4523 in C-Sets.}
C04B 41/4529	Coating or impregnating with a specific	{Coating or impregnating with a specific
	material from the gas phase is classified	material from the gas phase is classified
	according to the specific material and symbol	according to the specific material and symbol
	C04B 41/4529 is allocated in Combination	C04B 41/4529 is allocated in C-Sets.}
	Sets	-
C04B 41/4535	Coating or impregnation with a solution or a	{Coating or impregnation with a solution or a
	suspension of a specific material is classified	suspension of a specific material is classified
	according to the specific material and symbol	according to the specific material and symbol
	C04B 41/4535 is allocated in Combination	C04B 41/4535 is allocated in C-Sets.}
	Sets	
C04B 41/4545	Coating or impregnation with a specific	{Coating or impregnation with a specific
	powdery material is classified according to	powdery material is classified according to the
	the specific material and symbols C04B	specific material and symbols C04B 41/4545 -
	41/4545 - C04B 41/4549 are allocated in	C04B 41/4549 are allocated in C-Sets.}
	Combination Sets	
C04B 41/4811	In this group the following term is used with	{In this group the following term is used with
	the meaning indicated:	the meaning indicated:
	 "aldehydes" also covers other 	• "aldehydes" also covers other organic
	organic compounds reacting as	compounds reacting as aldehydes, e.g.
	aldehydes, e.g. glyoxylic acid	glyoxylic acid.}
C04B 41/5022	Glazing of concrete, natural or artificial stone	{Glazing of concrete, natural or artificial stone
	or ceramics is only classified in C04B	or ceramics is only classified in C04B41/5022
	41/5022 when non-compositional a spects are	when non-compositional a spects are important,
	important, e.g. a spects relating to the method	e.g. a spects relating to the method of
	of application or the choice of the substrate	application or the choice of the substrate.}
C04B 41/5025	In this subgroup, the materials considered as	{In this subgroup, the materials considered as
	ceramic materials are those covered by	cera mic materials are those covered by groups
	groups C04B 33/00 - C04B 35/83	C04B 33/00 - C04B 35/83.}
C04B	Code C04B 2103/0088 is only used when the	{Code C04B 2103/0088 is only used when the
2103/0088	chemical nature of the latent hydraulic	chemical nature of the latent hydraulic material
	material is not specified, when no specific	is not specified, when no specific group in
	group in subclass C04B exists for defining	subclass C04B exists for defining the material
	group in subclass Co-Devisios for defilling	success Co-Devises for defining the material

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Area	Current text	Proposed edit
	the material or when it is chosen from an	or when it is chosen from an important number
	important number of alternatives.	of alternatives.}
C04B	Code C04B 2111/00043 is only used in	{Code C04B 2111/00043 is only used in
2111/00043	combination with groups C04B 26/00 -	combination with groups C04B 26/00 - C04B
	C04B 26/32.	26/32.}
		·
C07F7/121	The silicon atom involved in the reaction that	{The silicon atom involved in the reaction that
	is attached or becomes attached to the	is attached or becomes attached to the highest
	highest number of halide atoms determines	number of halide atoms determines
	classification	classification.}
C07J41/0033	In groups C07J 41/0038 - C07J 41/0094 all	{In groups C07J 41/0038 - C07J 41/0094 all
	references to substituents in position 17-beta	references to substituents in position 17-beta of
	of the steroid skeleton include substituents at	the steroid skeleton include substituents at the
	the 17-position when there is a double bond	17-position when there is a double bond to or
	to or from position 17, and all references to	from position 17, and all references to an amide
	an amide group include all nitrogen	group include all nitrogen substituted carbonyl
	substituted carbonyl groups	groups.}
C07K1/306	Large single crystals of proteins from	{Large single crystals of proteins from
	solutions are classified in C30B7/00 for the	solutions are classified in C30B7/00 for the
	method and in C30B 29/58 for the crystal	method and in C30B 29/58 for the crystal.}
C08F4/005	Where a carrier is considered of particular	{Where a carrier is considered of particular
	interest a further classification may be made	interest a further classification may be made in
	in group C08F4/02.	group C08F4/02.}
C08F4/60003	For monoanionic compounds, the charge is	{For monoanionic compounds, the charge is on
	on the last mentioned atom; for dianionic	the last mentioned atom; for dianionic
	compounds, the charge is on the first and the	compounds, the charge is on the first and the
	last mentioned atoms except for compounds	last mentioned atoms except for compounds
	marked with * where the charge is on the	marked with * where the charge is on the
	marked atom	marked atom.}
C08F4/64003	For monoanionic compounds, the charge is	{For monoanionic compounds, the charge is on
	on the last mentioned atom; for dianionic	the last mentioned atom; for dianionic
	compounds, the charge is on the first and the	compounds, the charge is on the first and the
	last mentioned atoms except for compounds	last mentioned atoms except for compounds
	marked with * where the charge is on the	marked with * where the charge is on the
C08F4/68008	marked atom	marked atom.}
CU8F 4/08008	For monoanionic compounds, the charge is	{For monoanionic compounds, the charge is on
	on the last mentioned atom; for dianionic	the last mentioned atom; for dianionic
	compounds, the charge is on the first and the	compounds, the charge is on the first and the
	last mentioned atoms except for compounds	last mentioned atoms except for compounds
	marked with * where the charge is on the marked atom	marked with * where the charge is on the marked atom.}
C08F4/69008	For monoanionic compounds, the charge is	{For monoanionic compounds, the charge is on
C001:4/03000	on the last mentioned atom; for dia nionic	the last mentioned atom; for dianionic
	compounds, the charge is on the first and the	compounds, the charge is on the first and the
	last mentioned atoms except for compounds	last mentioned atoms except for compounds
	marked with * where the charge is on the	marked with * where the charge is on the
	marked atom	marked atom.}
C08F4/7001	For monoanionic compounds, the charge is	{For monoanionic compounds, the charge is on
2001 4/ /001	on the last mentioned atom; for dianionic	the last mentioned atom; for dianionic
	compounds, the charge is on the first and the	compounds, the charge is on the first and the
	compounds, incentage is on the first and the	compounds, incentarge is on the rust and the

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Area	Current text	Proposed edit
	last mentioned atoms except for compounds	last mentioned atoms except for compounds
	marked with * where the charge is on the	marked with * where the charge is on the
G00G 65 /0640	marked atom	marked atom.}
C08G65/2642	 In this group classification is made according to the metal in the compounds, if any In this group boron is considered a metal 	{1. In this group classification is made according to the metal in the compounds, if any.} {2. In this group boron is considered a metal
	and magnesium as an alkaline earth metal	and magnesium as an alkaline earth metal.}
C09C 1/0015	1. {The optical properties of the interference pigments are depending on the order of the different layers applied on the substrate in view of their refractive indices; A refractive index < or = 1.8 is considered low, a refractive index > 1.8 is considered high; A dye is a lways an organic, coloured material. An a luminium lake compound would for classification purposes also fall under this definition, as well as any coloured metal chelate or metal complex with organic ligands; An interference pigment can e.g. have a flaky, spherical or ellipsoidal core; A pigment comprising a core consisting of a metal is only considered as an interference pigment if it shows properties typical for interference pigments} 2. In groups C09C 1/0015 - C09C 1/0075 it is desirable to add indexing codes relating to the compositional and structural details chosen from groups C09C 2200/00 - C09C 2220/20	{1. The optical properties of the interference pigments are depending on the order of the different layers applied on the substrate in view of their refractive indices; A refractive index < or = 1.8 is considered low, a refractive index > 1.8 is considered high; A dye is always an organic, coloured material. An aluminium lake compound would for classification purposes also fall under this definition, as well as any coloured metal chelate or metal complex with organic ligands; An interference pigment can e.g. have a flaky, spherical or ellipsoidal core; A pigment comprising a core consisting of a metal is only considered as an interference pigment if it shows properties typical for interference pigments.} {2. In groups C09C 1/0015 - C09C 1/0075 it is desirable to add indexing codes relating to the compositional and structural details chosen from groups C09C 2200/00 - C09C 2220/20.}
C09C 1/3607	Combinations of treatment steps, characterised by the sequence or the nature of two or more individual steps, are classified in C09C 1/3692. The individual steps are classified with	{1. Combinations of treatment steps, characterised by the sequence or the nature of two or more individual steps, are classified in C09C 1/3692.} {2. The individual steps are classified with
	symbols chosen from groups C09C 1/3615 - C09C 1/3684.	symbols chosen from groups C09C 1/3615 - C09C 1/3684.}
C09C3/006	When classifying in this group, it is desirable to classify the individual treatment steps with symbols chosen from groups C09C 3/04 - C09C 3/12.	{When classifying in this group, it is desirable to classify the individual treatment steps with symbols chosen from groups C09C 3/04 - C09C 3/12.}
C12N5/0602	Three-dimensional culture, tissue culture or organ culture are classified with the corresponding cells, if not specially provided for	{Three-dimensional culture, tissue culture or organ culture are classified with the corresponding cells, if not specially provided for.}
C12N5/0634	Committed progenitors are classified with their progeny	{Committed progenitors are classified with their progeny.}

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Area	Current text	Proposed edit
		•
C12N15/8209	Standard selectable markers such as neomycin phosphotransferase (NPT) are not systematically classified in C12N 15/8209	{Standard selectable markers such as neomycin phosphotransferase (NPT) are not systematically classified in C12N 15/8209.}
C12N15/825	Transgenic plants with a ltered flower morphology are also classified in this group	{Transgenic plants with a ltered flower morphology are also classified in this group.}
C12N15/8509	Additional aspects of the modified a nimals are classified in the groups A01K2207/00 - A01K2267/00	{Additional aspects of the modified animals are classified in the groups A01K 2207/00 - A01K 2267/00.}
C22C 1/1094	Documents classified in group C22C 1/1094 are also classified in subclass C22F	{Documents classified in group C22C 1/1094 are also classified in subclass C22F.}
D06M 2101/005	Blends of fibres are indexed according to each constituent fibre	{Blends of fibres are indexed according to each constituent fibre.}
G01N30/6095	Attention is drawn to the Notes following the titles of class B81 and subclass B81B relating to "microstructural devices" and "microstructural systems" and the Notes following the title of subclass B82B relating to "nanostructures"	{Attention is drawn to the Notes following the titles of class B81 and subclass B81B relating to "microstructural devices" and "microstructural systems" and the Notes following the title of subclass B82B relating to "nanostructures".}
G01N31/007	The observation of the progress of the reaction specified below by any of the methods specified in groups G01N 3/00 - G01N 3/00 - G01N 29/00, if this is of major importance, is dealt with in the group concerned.	Delete the entire Note.
G01R 31/282	References listed below indicate CPC places which could also be of interest when carrying out a search in respect of the subject matter covered by the preceding group: • testing of individual LEDs G01R 31/2635 • testing of lamps G01R 31/44 • testing of displays and display drivers, e.g. LCDs G09G 3/006 • testing of ADCs or DACs H03M 1/1071	{References listed below indicate CPC places which could also be of interest when carrying out a search in respect of the subject matter covered by the preceding group: • testing of individual LEDs G01R 31/2635 • testing of lamps G01R 31/44 • testing of displays and display drivers, e.g. LCDs G09G 3/006 • testing of ADCs or DACs H03M 1/1071.}
G01N33/6878 G02F1/0009	{in eptitope analysis} G02F 1/0009 and subgroups contain mostly non-patent literature	{in epitope analysis} {G02F 1/0009 and subgroups contain mostly non-patent literature.}
G03F7/70191	Wavelength or polarisation control is further classified in groups G03F7/70566, G03F7/70575	{Wavelength or polarisation control is further classified in groups G03F7/70566 and G03F7/70575.}
G03F7/70225	Catadioptric systems are further classified in group G02B 17/0892	{Catadioptric systems are further classified in group G02B 17/0892.}

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Area	Current text	Proposed edit
G03F7/70233	Further a spects of catoptric systems are	{Further a spects of catoptric systems are
	classified in group G02B 17/06	classified in group G02B 17/06.}
G03F7/70241	Further a spects of refractive systems are	{Further a spects of refractive systems are
G0075 (5000	classified in group G02B 13/143	classified in group G02B 13/143.}
G03F7/70308	Wavelength or polarisation control is further	{Wavelength or polarisation control is further
	classified in groups G03F7/70566, G03F 7/70575	classified in groups G03F7/70566 and G03F 7/70575.}
G03F7/70316	1. Particular optical materials are	{1. Particular optical materials are further
	further classified in group G03F	classified in group G03F7/70958.}
	7/70958;	{2. Multila yer reflectors for X-ray or EUV
	2. Multilayer reflectors for X-ray or	lithography are further classified in group
	EUV lithography are further	G21K1/062.}
	classified in group G21K 1/062	
G03F7/70741	Protective means, e.g. containers, for masks,	{Protective means, e.g. containers, for masks,
	blanks or pellicles, are further classified in	blanks or pellicles, are further classified in
	group G03F 1/66	group G03F 1/66.}
G03G5/0528	In groups G03G 5/0528 - G03G 5/0596, in	{In groups G03G 5/0528 - G03G 5/0596, in the
	the absence of an indication to the contrary, a	absence of an indication to the contrary, a
	polymer is classified in the last appropriate	polymer is classified in the last appropriate
G02G5/0662	place	place.}
G03G5/0662	Alcoholates, phenates or organic acid salts of alka li or alkaline earth metals are classified	{Alcoholates, phenates or organic acid salts of alkali or alkaline earth metals are classified as
G03G5/14713	as the parent compounds In groups G03G 5/14713 - G03G 5/14795, in	the parent compounds.} {In groups G03G 5/14713 - G03G 5/14795, in
00303/14/13	the absence of an indication to the contrary, a	the absence of an indication to the contrary, a
	polymer is classified in the last appropriate	polymer is classified in the last appropriate
	place	place.}
H01M 4/5825	Polyanionic structures comprises elements	{Polyanionic structures comprises elements not
	not changing oxidation state during	changing oxidation state during
	electrochemical reaction, e.g. P, Si, B	electrochemical reaction, e.g. P, Si, B.}
Definitions	/ 0 / /	/ 6 / / 1
B33Y	Processes for laying down cocoa products,	Processes for laying down cocoa products, e.g.
Informative	e.g. chocolate in moulds or drop-by-drop on	chocolate in moulds or drop-by-drop on a
references	a surface, optionally with the associated	surface, optionally with the associated heating,
	hating, cooling portioning, cutting cast-tail,	cooling, portioning, cutting cast-tail, anti-drip
	anti-drip processes	processes

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PUBLICATION DATE: MAY 1, 2025

Editorial Corrections from project EC12403

Area	Current text	Proposed edit
B41C 1/025	Attention is drawn to the title of class B41	{Attention is drawn to the title of class B41
	and to subclass H04N, in particular to the	and to subclass H04N, in particular to the
	Notes following the title of that subclass	Notes following the title of that subclass and
	and to the group H04N 1/00	to the group H04N 1/00.}
B41C 1/05	The fabrication of lithographic forms,	{The fabrication of lithographic forms, screen
	screen printing forms or stencils with a laser	printing forms or stencils with a laser beam or
	beam or another high energetic radiation	another high energetic radiation beam is not
	beam is not considered as involving an	considered as involving an engraving. The
	engraving. The preparation of such forms is	preparation of such forms is covered by B41C
B60C 23/005	covered by B41C 1/10 and B41C 1/14	1/10 and B41C 1/14.} {B60C 23/001, B60C 23/02, B60C 23/04,
B00C 23/003	B60C 23/001, B60C 23/02, B60C 23/04, B60C 23/06 or B60C 23/08	B60C 23/06 or B60C 23/08.}
	B00C 23/0001 B00C 23/08	BOOC 23/0001 BOOC 23/08.}
B60C 25/002	When classifying in this group,	{When classifying in this group, classification
	classification is also made in the appropriate	is also made in the appropriate subgroups of
	subgroups of B60C25/0548	B60C 25/0548.}
B81B	1. This subclass does not cover:	1. This subclass does not cover:
	 purely electrical or electronic devices 	 purely electrical or electronic devices per
	per se which are covered by section H, e.g.	se which are covered by section H, e.g.
	subclass H01L or class H10;	subclass H01L or class H10;
	– purely optical devices per se which are	– purely optical devices per se which are
	covered by subclasses G02B or G02F;	covered by subclasses G02B or G02F;
	– essentially two-dimensional structures,	essentially two-dimensional structures,
	e.g. layered products which are covered by subclass B32B;	e.g. layered products which are covered by subclass B32B;
	- chemical or biological structures per se	- chemical or biological structures per se
	which are covered by section C;	which are covered by section C;
	- structures in atomic scale produced by	- structures in a tomic scale produced by
	manipulation of single atoms or molecules,	manipulation of single atoms or molecules,
	which are covered by group B82B 1/00. 2. Devices or systems classified in this	which are covered by group B82B 1/00. 2. Devices or systems classified in this
	subclass are also classified in appropriate	subclass are also classified in appropriate
	subclasses providing for their structural or	subclasses providing for their structural or
	functional features, if such features are of	functional features, if such features are of
	interest.	interest.
	3. Attention is drawn to the following	{3. Attention is drawn to the following places:
	places: A61K9/50 Microcapsules for	A61K9/50 Microcapsules for medicinal
	medicinal preparations B25J 7/00	preparations
	Micromanipulators G02B 21/32	B25J7/00 Micromanipulators G02B21/32
	Micromanupulators combined with	Micromanupulators combined with
	microscopes G11B 5/127 Magnetic heads	microscopes
	H01P3/08 Waveguide microstrips.	G11B 5/127 Magnetic heads
	4. In this subclass, local "residual"	H01P3/08 Waveguide microstrips.}
	subgroups, e.g. B81B 7/0077, are used with	{4. In this subclass, local "residual"
	the following purpose: When classifying a	subgroups, e.g. B81B 7/0077, are used with
	document which does not fit in any of a set	the following purpose: When classifying a

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Area	Current text	Proposed edit
	of subgroups with the same dot-level, the	document which does not fit in any of a set of
	document should be classified in the	subgroups with the same dot-level, the
	residual group, if present, and not in the	document should be classified in the residual
	group at the hierarchical level one dot	group, if present, and not in the group at the
	above.	hierarchical level one dot above.
	In the example, the document shall be	In the example, the document shall be
	classified in B81B7/0077 and not in B81B	classified in B81B7/0077 and not in B81B
	7/0032 as B81B 7/0077 is "residual" to	7/0032 as B81B 7/0077 is "residual" to B81B
	B81B 7/0035 - B81B 7/0074	7/0035 - B81B7/0074.}
B81B7/008	1. This group <u>covers</u> : only MEMS with an	{1. This group <u>covers</u> : only MEMS with an
	electronic circuit which is not specific	electronic circuit which is not specific to a
	to a particular application.	particular application.}
	2. This group <u>does not cover</u> : electronic	{2. This group does not cover: electronic
	circuits <u>per se</u> , e.g. for controlling or	circuits <u>per se</u> , e.g. for controlling or driving
G013 # 1 7 /0 /	driving application specific MEMS	application specific MEMS.}
G01M 15/04	Group G01M 15/05 takes precedence over	Group G01M 15/05 takes precedence over
	groups G01M 15/042 and G01M 15/06 -	groups {G01M 15/042 and} G01M 15/06-
G013 # 00 /007	G01M 15/12.	G01M 15/12.
G01M 99/005	This group <u>covers</u> mechanical testing of	{This group <u>covers</u> mechanical testing of
	complete machines	complete machines.}
C01D 11/00	1 C CO1D 11/40 CO1D 11/50	1 C C01D 11/40 C01D 11/5(4-1
G01R 11/00	1. Groups G01R 11/48 - G01R 11/56	1. Groups G01R 11/48 - G01R 11/56 take
	take precedence over groups G01R 11/30 - G01R 11/46.	precedence over groups G01R 11/30 - G01R 11/46.
	{This Note corresponds to IPC Note (1) relating to G01R 11/30 -	{This Note corresponds to IPC Note (1) relating to G01R 11/30 - G01R 11/46.}
	G01R 11/46.}	{2. For the definition of "arrangement" see
	2. For the definition of	Note (2) under G01R.}
	"arrangement" see Note (2) under	Note (2) under GOTK.
	G01R	
G01R 31/282	References listed below indicate CPC	{References listed below indicate CPC places
G011C31/202	places which could also be of interest when	which could also be of interest when carrying
	carrying out a search in respect of the	out a search in respect of the subject matter
	subject matter covered by the preceding	covered by the preceding group:
	group:	-testing of individual LEDs G01R 31/2635 -
	testing of individual LEDs G01R 31/2635	testing of lamps G01R31/44
	-testing of lamps G01R31/44-testing of	testing of displays and display drivers, e.g.
	displays and display drivers, e.g. LCDs	LCDs G09G 3/006
	G09G3/006	- testing of ADCs or DACs H03M 1/1071.}
	-testing of ADCs or DACs H03M 1/1071	
G01R 33/56518	This group only covers correction of	{This group only covers correction of artifacts
	artifacts caused by gradient-non-linearity	caused by gradient-non-linearity.}
G01S 5/0252	In this group, the following terms are used	{In this group, the following terms are used
	with the meaning indicated:	with the meaning indicated:
	-Radio frequency fingerprints mean	- Radio frequency fingerprints mean
	mea surements or simulated values of radio	mea surements or simulated values of radio
	frequency signal parameters, e.g. receiver	frequency signal parameters, e.g. receiver
	signal strength indicator [RSSI] or	signal strength indicator [RSSI] or identifiers
	identifiers or access point identifiers	or access point identifiers [ApIds] combined

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Area	Current text	Proposed edit
	[ApIds] combined with coordinates of the	with coordinates of the positions at which the
	positions at which the radio frequency	radio frequency fingerprints were measured.
	fingerprints were measured. – "Radio-map"	- "Radio-map" means a collection of radio
	means a collection of radio frequency	frequency fingerprints.}
	fingerprints.	
G01T 1/361	G01T 1/361 takes precedence over G01T	{G01T 1/361 takes precedence over G01T
	1/362	1/362.}
G02B 6/0065	When classifying in this group,	When classifying in this group, classification
	classification must also be made in one or	must also be made in one or more of the
	more of the groups of G02B 6/0013 or	groups of G02B 6/0013 or G02B 6/0033 for
G00D 5/0051 5	G02B 6/0033 for the related device aspects	the related device a spects.}
G02B 6/03616	A layer is characterised by an abrupt change	{1. A layer is characterised by an abrupt
	in refractive index gradient, e.g. by the layer	change in refractive index gradient, e.g. by the
	having a maximum or minimum or the layer	la yer ha ving a maximum or minimum or the
	being between two points of inflexion, such	la yer being between two points of inflexion,
	that a graded boundary as in a trapezoidal	such that a graded boundary as in a
	core is not counted as a separate layer. 2.	tra pezoidal core is not counted as a separate
	The innermost high index core layer is the first layer starting from the central core after	layer.} {2. The innermost high index core layer is the
	which the refractive index decreases. 3. +	first layer starting from the central core after
	and - refer respectively to the relative	which the refractive index decreases.}
	refractive index difference	{3. + and - refer respectively to the relative
	increase/decrease of a djacent la yers starting	refractive index difference increase/decrease
	from the innermost highest index core layer	of a djacent layers starting from the innermost
	and continuing in a radially outward	highest index core layer and continuing in a
	direction	radially outward direction.
G02B 6/42	In this group, the following expression is	{In this group, the following expression is
	used with the meaning indicated:	used with the meaning indicated:
	- "opto-electronic elements" includes light	– "opto-electronic elements" includes light
	emitting elements, e.g. la sers or LED's, as	emitting elements, e.g. la sers or LED's, as
	well as light receiving elements, e.g.	well as light receiving elements, e.g.
	photodiodes or phototransistors	photodiodes or phototransistors.}
G02B 13/00	Unless specified in the title of the	{Unless specified in the title of the subgroups,
	subgroups, this group and its subgroups do	this group and its subgroups do not cover
	not cover objectives comprising reflecting	objectives comprising reflecting surfaces,
	surfaces, which are covered by G02B 17/06,	which are covered by G02B 17/06, G02B
	G02B 17/08 and their subgroups	17/08 and their subgroups.}
G02B 13/002	When classifying in this group, a lens is	{When classifying in this group, a lens is
	deemed to be a simple lens or a compound	deemed to be a simple lens or a compound
	lens	lens.}
G02B 21/0024	Objective revolvers or the like are classified	{Objective revolvers or the like are classified
C02D 27/01	in other groups of G02B 21/00	in other groups of G02B21/00.}
G02B 27/01	Details of head-up displays covered by	{Details of head-up displays covered by
	G02B 27/01 but not provided for in this	G02B 27/01 but not provided for in this group
	group are also to be classified under G02B	are also to be classified under G02B 27/01
C05C	27/01 and subgroups	and subgroups.}
G05G	Provisional indexing codes related to	{Provisional indexing codes related to scheme
2009/04781	scheme of trilateral project T021	of trilateral project T021.}

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Area	Current text	Proposed edit
Alca	Current text	1 Toposeu euit
G06K7/10009	This group covers electromagnetic interrogation as radiated by the antenna of an interrogation device while interrogating a plurality of wireless electronic memory record carriers, e.g. non-contact smart cards, RFID tags or labels, or transponders	{This group covers electromagnetic interrogation as radiated by the antenna of an interrogation device while interrogating a plurality of wireless electronic memory record carriers, e.g. non-contact smart cards, RFID tags or labels, or transponders.}
G08B 13/1427	Details thereof are further classified in the subgroups of G08B 21/0202	{Details thereof are further classified in the subgroups of G08B21/0202.}
G11B 3/60	contains no documents, see G11B 19/2009	{contains no documents, see G11B 19/2009.}
G11B 3/61	see provisionally also G11B3/60, G11B3/589 and G11B17/02; contains no documents, see G11B19/2018	{see provisionally a lso G11B 3/60, G11B 3/589 and G11B 17/02; contains no documents, see G11B 19/2018.}
G11B 5/5521	For groups G11B 5/5526 - G11B 5/5582, <u>see</u> provisionally G11B 5/5521 and G11B 5/596	{For groups G11B 5/5526-G11B 5/5582, see provisionally G11B 5/5521 and G11B 5/596.}
G11B 5/596	For groups G11B 5/59605 - G11B 5/59633, see provisionally G11B 5/5521 and G11B 5/596	{For groups G11B 5/59605 - G11B 5/59633, see provisionally G11B 5/5521 and G11B 5/596.}
G11B 11/22	see provisionally G11B 9/06, G11B 9/07; G11B 11/05	{see provisionally G11B9/06, G11B 9/07; G11B 11/05.}
G11B 15/026	see provisional also G11B 15/005	{see provisional also G11B 15/005.}
G11B 15/03	see prov. also G11B15/00, G11B27/00	{s <u>ee</u> prov. also G11B 15/00 <u>, G11B 27/00</u> .}
G11B 15/05	<u>see</u> prov. also G11B15/0 <u>2</u>	{s <u>ee</u> provisional also G11B 15/0 <u>2</u> .}
G11B 15/07	see provisional also G11B 15/06	{s <u>ee</u> provisional also G11B 15/0 <u>6</u> .}
G11B 15/087	see provisional also G11B 15/ <u>06, G11B</u> <u>15/02, G11B 27/00</u>	{see provisional also G11B 15/ <u>06, G11B</u> <u>15/02, G11B 27/00.</u> }
G11B 15/093	see provisional also G11B 15/16, G11B 15/22, G11B 15/46	{ <u>see</u> provisional also G11B 15/ <u>16, G11B</u> <u>15/22, G11B 15/46.</u> }
G11B 15/17	<u>see</u> prov. also G11B15/ <u>16</u>	{s <u>ee</u> prov. also G11B15/ <u>16</u> .}
G11B 15/473	<u>see</u> prov. also G11B 5/5 <u>88</u>	{s <u>ee</u> prov. Also G11B 5/5 <u>88</u> .}
G11B 17/24	Group G11B 17/30 takes precedence over groups G11B 17/24 – G11B 17/28.	{Group G11B 17/30 takes precedence over groups G11B 17/24 – G11B 17/28.}

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Area	Current text	Proposed edit
G11B 23/0007	This group is closed down and will in due	{This group is closed down and will in due
	course be transferred to G11B 20/22 and	course be transferred to G11B 20/22 and
	G11B 20/24 and subgroups	G11B 20/24 and subgroups.}
G11C 11/06007	Provisionally contains the following details;	{Provisionally contains the following details;
	control write -, read -, address circuitry	control write -, read -, address circuitry (pulse
	(pulse generators in general H03K 5/00,	generators in general H03K 5/00, H03K
	H03K17/00); arrangements for	17/00); arrangements for temperature
	temperature compensation; checking of the	compensation; checking of the correct
	correct functioning and repair arrangements	functioning and repair arrangements
	(checking methods in general G06F 11/00,	(checking methods in general G06F11/00,
	G06F 11/28; testing magnetic elements <u>per</u>	G06F11/28; testing magnetic elements per se
	se G01R 33/00); magnetic properties,	G01R 33/00); magnetic properties, choice of
	choice of materials or the like (materials per	materials or the like (materials <u>per se</u> H01F
	<u>se</u> H01F1/00)	1/00)}
H01F	In this subclass, inductances and	{In this subclass, inductances and
	transformers are regarded as being "for	transformers are regarded as being "for power
	power supply" if they are intended for this	supply" if they are intended for this purpose
	purpose even in systems operating at	even in systems operating at frequencies
110151/047	frequencies above 60 cycles/sec.	above 60 cycles/sec.}
H01F1/047	In groups H01F 1/053 - H01F 1/059, an	{In groups H01F 1/053 - H01F 1/059, an alloy
	alloy is classified in the last appropriate	is classified in the last appropriate place.}
H01E1/147	place	(I.,
H01F1/147	In groups H01F 1/14708 - H01F 1/15391,	{In groups H01F 1/14708 - H01F 1/15391, an
	an alloy is classified in the last appropriate place	alloy is classified in the last appropriate place.}
H01F1/401	In group H01F 1/401, a diluted magnetic	{In group H01F 1/401, a diluted magnetic
HUIF 1/401	semiconductor (DMS) is classified in the	semiconductor (DMS) is classified in the last
	last appropriate place	appropriate place.}
H01F10/14	In this group, a lloys containing iron or	{In this group, a lloys containing iron or nickel
11011-10/14	nickel are classified in the last appropriate	are classified in the last appropriate place.
	place	are classified in the last appropriate place.
H01L21/02002	1. This group <u>covers</u> processes for	{1. This group <u>covers</u> processes for
1101221/02002	manufacturing wa fers prior to the	manufacturing wa fers prior to the fabrication
	fabrication of any device, i.e. between	of any device, i.e. between the sawing of
	the sawing of ingots (covered by	ingots (covered by B28D) and the cleaning of
	B28D) and the cleaning of substrates	substrates (covered by H01L 21/02041).}
	(covered by H01L 21/02041).	{2. This group does not cover:
	2. This group does not cover:	simple use of grinding or polishing
	• simple use of grinding or polishing	machines B24B
	machines B24B	• thermal smoothening H01L21/324.}
	• thermal smoothening H01L21/324	,
H01L21/02112	Layers comprising sublayers, i.e. multi-	{Layers comprising sublayers, i.e. multi-
	layers, are additionally classified in H01L	layers, are additionally classified in H01L
	21/022; porous layers are additionally	21/022; porous layers are additionally
	classified in H01L21/02203	classified in H01L21/02203.}
H01L21/02129	Halogen, e.g. fluorine, containing BPSG,	{Halogen, e.g. fluorine, containing BPSG,
	PSG, BSG, and the like, are additionally	PSG, BSG, and the like, are additionally
	classified in H01L21/02131	classified in H01L21/02131.}
H01L21/02164	The formation of silicon oxide layers is	{The formation of silicon oxide layers is
i	classified in this group regardless of the	classified in this group regardless of the

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precursor or of the procase of explicit statem rest-groups, or on mat H01L21/02126 and s		precursor or of the process of formation; in
rest-groups, or on mat		precursor or or the process or rolliauoil, iii
		case of explicit statements on doping, on rest-
H01L 21/02126 and s		groups, or on material components see H01L
•		21/02126 and subgroups; deposition of silicon
of silicon oxide from		oxide from organic precursors without further
without further statem		statements on film composition is classified
composition is classif 21/02205 and subgrou	ıps	here and in H01L 21/02205 and subgroups.}
H01L21/02214 This group does not c		{This group does not cover mixtures of a
silane and oxygen		silane and oxygen. }
H01L21/02219 This group does not c	over mixtures of	This group does not cover mixtures of silane
silane and nitrogen		and nitrogen.}
Shane and microgen		und mirogem)
H01L 21/02227 Subject matter classif	ed in the range of	{Subject matter classified in the range of
H01L 21/0223 - H01I		H01L 21/0223 - H01L 21/02249 is
additionally classified		additionally classified in H01L21/02249,
H01L 21/02255 and F		H01L 21/02255 and H01L 21/02252,
depending on the type		depending on the type of reaction.}
H01L 21/02263 This group and subgro		{This group and subgroups also cover
deposition methods in		deposition methods in which the gas or vapour
va pour is produced by		is produced by physical means, e.g. a blation
a blation from targets of	or heating of source	from targets or heating of source material.}
material H01L21/02269 Subject matter relatin	ato mologular hoom	(Subject metter relating to melogular beam
H01L 21/02269 Subject matter relating epitaxy is classified in		{Subject matter relating to molecular beam epitaxy is classified in this group.}
epitaxy is classified in	tills group	epitaxy is classified in this group.
H01L21/0228 Subject matter relating	g to cyclic pla sma	{Subject matter relating to cyclic plasma
CVD is additionally c		CVD is additionally classified in H01L
21/02274		21/02274.}
H01L21/02293 Formation of non-epit	axial layers by MBE,	{Formation of non-epitaxial layers by MBE,
ALE, etc. is not cover		ALE, etc. is not covered by this group; for
MBE see H01L 21/02		MBE <u>see</u> H01L 21/02269; for ALE <u>see</u> H01L
H01L 21/0228		21/0228.}
H01L 21/02296 This group and subgroup processes which are d		{This group and subgroups only cover processes which are directly linked to the
la yer formation; routin		la yer formation; routine anneals, i.e. thermal
thermal treatment with		treatment without further features like a
like a special atmosph		special atmosphere, presence of a plasma,
pla sma, thermally ind		thermally induced chemical reactions, change
reactions, change of p		of phase (crystal structure) etc. are not
structure) etc. are not cleaning see H01L 21		classified here; for cleaning <u>see</u> H01L 21/02041 and subgroups; for etching
subgroups; for etching		processes see H01L21/311 and subgroups;
21/311 and subgroups		for planarization processes see H01L
processes see H01L2		21/31051 and subgroups; for processes to
subgroups; for proces		repair etch damage see H01L 21/3105 and
damage see H01L21/	-	subgroups.}
H01L 21/02299 This group and subgroup		This group and subgroups cover treatments
to improve adhesion of		to improve adhesion or change the surface

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Area	Current text	Proposed edit
	termination; for etching see H01L 21/306	termination; for etching see H01L 21/306 and
	and subgroups and H01L 21/311 and	subgroups and H01L 21/311 and subgroups.}
	subgroups	
H01L21/02301	Subject matter relating to the cleaning	{Subject matter relating to the cleaning
	processes for semiconductor devices in	processes for semiconductor devices in
	general is covered by H01L 21/02041 and	general is covered by H01L 21/02041 and
	subgroups	subgroups.}
H01L21/02318	This group only covers processes that are	{This group only covers processes that are
	part of the layer formation; treatments	part of the layer formation; treatments which
	which are performed after completion of the	are performed after completion of the
	insulating layer are covered by H01L	insulating layer are covered by H01L 21/3105
	21/3105 and subgroups	and subgroups.}
H01L21/02321	processes like the introduction of	{Processes like the introduction of phosphorus
	phosphorus into silicon oxide by diffusion,	into silicon oxide by diffusion, or doping of an
	or doping of an already existing insulating	already existing insulating layer are covered
	layer are covered by this group and	by this group and subgroups; for the method
	subgroups; for the method of introduction,	of introduction, see H01L21/02337, H01L
	see H01L21/02337, H01L21/02343, H01L	21/02343, H01L 21/02345 and subgroups.}
	21/02345 and subgroups	
H01L21/02334	Subject matter relating to the cleaning	{Subject matter relating to the cleaning
	processes for semiconductor devices in	processes for semiconductor devices in
	general is covered by H01L 21/02041 and	general is covered by H01L 21/02041 and
	subgroups	subgroups.}
H01L21/0405	This group <u>covers</u> passivation	{This group <u>covers</u> passivation.}
H01L21/046	Processes where ion implantation of boron	{Processes where ion implantation of boron
	and subsequent annealing does not produce	and subsequent annealing does not produce a
	a p-doped region are classified elsewhere,	p-doped region are classified elsewhere, e.g.
	e.g. H01L 21/0445	H01L21/0445.}
H01L21/28017	This group <u>covers</u> deposition of the	{This group covers deposition of the
	insulators, including epitaxial insulators,	insulators, including epitaxial insulators, and
	and the conductors within the same process	the conductors within the same process or
	or chamber	chamber.}
H01L21/28026	When the final conductor comprises a	{When the final conductor comprises a
	superconductor, subject matter is not	superconductor, subject matter is not
	classified according to the subgroups H01L	classified according to the subgroups H01L
	21/28035 - H01L 21/28097. Instead, it is	21/28035 - H01L 21/28097. Instead, it is
	classified in H01L21/28026	classified in H01L21/28026.}
H01L21/28035	A very thin, e.g. silicon, adhesion or seed	{A very thin, e.g. silicon, adhesion or seed
	layer is not considered as the one next to the	layer is not considered as the one next to the
	insulator	insulator.}
H01L21/28061	To assess the coverage of groups H01L	{To assess the coverage of groups H01L
	21/28052 and H01L 21/28061, barrier	21/28052 and H01L 21/28061, barrier layers,
	layers, e.g. TaSiN, are not considered	e.g. TaSiN, are not considered.}
H01L21/28114	Documents are also classified in groups	{Documents are also classified in groups
	H01L21/28035 - H01L21/28105 when the	H01L21/28035 - H01L21/28105 when the
	composition is also relevant	composition is also relevant.}
H01L21/28211	thin oxidation layers used as a barrier layer	{Thin oxidation layers used as a barrier layer
	or as a buffer layer, e.g. before the fomation	or as a buffer layer, e.g. before the fomation

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Area	Current text	Proposed edit
	of a high-k insulator, are classified here	of a high-k insulator, are classified here only
	only if important per se	if important per se.}
H01L 21/3225	Gettering using both extrinsic and intrinsic	{Gettering using both extrinsic and intrinsic
	gettering techniques is classified in both	gettering techniques is classified in both H01L
	H01L 21/3221 and H01L 21/3225	21/3221 and H01L 21/3225.}
H01L21/48	In this group, the expression "treatment"	{In this group, the expression "treatment"
	covers also the removal of leads from parts	covers also the removal of leads from parts.}
H01L21/50	Arrangements for connecting or	{Arrangements for connecting or
	disconnecting semiconductor or other solid	disconnecting semiconductor or other solid
	state bodies, or methods related thereto,	state bodies, or methods related thereto, other
	other than those arrangements or methods	than those arrangements or methods covered
	covered by the following subgroups, are	by the following subgroups, are covered by
	covered by H01L 24/00	H01L24/00.}
H01L21/67	In this subgroup the term substrate	{In this subgroup the term substrate
	designates a semiconductor or electric solid	designates a semiconductor or electric solid
******	state device or component, or a wafer	state device or component, or a wafer.}
H01L21/6835	H01L21/6835, details of the apparatus are	{H01L21/6835, details of the apparatus are to
	to be further indexed using the indexing	be further indexed using the indexing codes
	codes chosen from H01L 2221/68304 and	chosen from H01L 2221/68304 and
***************************************	subgroups	subgroups.}
H01L21/768	Groups H01L 21/768 - H01L	{Groups H01L21/768 - H01L21/76898cover
	21/76898cover multi-step processes for	multi-step processes for manufacturing
	manufacturing interconnections.	interconnections. Information peculiar to
	Information peculiar to single-step	single-step processes should also be classified
	processes should also be classified in the	in the corresponding group, e.g. – cleaning H01L 21/02041 – etching H01L 21/311,
	corresponding group, e.g. – cleaning H01L 21/02041 – etching H01L 21/311, H01L	H01L21/3213 – masking H01L21/327, H01L
	21/3213 – masking H01L 21/311, H01L 21/3213 – masking H01L 21/027, H01L	21/033, H01L21/31144, H01L21/32139 –
	21/033, H01L21/31144, H01L21/32139 –	planarizing H01L 21/3105, H01L 21/321.}
	planarizing H01L 21/3105, H01L 21/321	
H01L21/76838	When the interconnect is also used as the	{When the interconnect is also used as the
1101121/70030	conductor part of a conductor insulator	conductor part of a conductor insulator
	semiconductor electrode (gate level	semiconductor electrode (gate level
	interconnections), documents are classified	interconnections), documents are classified in
	in the relevant electrode manufacture	the relevant electrode manufacture groups,
	groups, e.g. H01L 21/28026	e.g. H01L21/28026.}
H01L21/77	Integration processes for the manufacture of	{Integration processes for the manufacture of
	devices of the type classified in H01L	devices of the type classified in H01L 27/14,
	27/14, H01L 27/15, H10N 19/00, H10N	H01L27/15, H10N19/00, H10N39/00,
	39/00, H10N 59/00, H10N 79/00, H10N	H10N 59/00, H10N 79/00, H10N 89/00,
	89/00, H10K 19/00, H10K 39/00, H10K	H10K19/00, H10K39/00, H10K59/00 and
	59/00 and H10K 65/00 are not classified in	H10K 65/00 are not classified in this group
	this group and its sub-groups. Instead, as	and its sub-groups. Instead, as they are
	they are peculiar to said devices, they are	peculiar to said devices, they are classified
	classified together with the devices	together with the devices Multistep processes
	Multistep processes for manufacturing	for manufacturing memory structures in
	memory structures in general using field	general using field effect technology are
	effect technology are covered by H10B	covered by H10B 99/00; Multistep processes
	99/00; Multistep processes for	for manufacturing dynamic random access
	manufacturing dynamic random access	memory structures are covered by H10B

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Area	Current text	Proposed edit
11100	memory structures are covered by H10B	12/01; Multistep processes for manufacturing
	12/01; Multistep processes for	static random access memory structures are
	manufacturing static random access	covered by H10B 10/00; Multistep processes
	memory structures are covered by H10B	for manufacturing read-only memory
	10/00; Multistep processes for	structures are covered by H10B 20/00;
	manufacturing read-only memory structures	Multistep processes for manufacturing
	are covered by H10B 20/00; Multistep	electrically programmable read-only memory
	processes for manufacturing electrically	structures are covered by H10B 69/00.}
	programmable read-only memory structures	structures are covered by 1110B 09700.
	are covered by H10B 69/00	
H01L23/48	Arrangements for connecting or	{Arrangements for connecting or
11011223/40	disconnecting semiconductor or other solid	disconnecting semiconductor or other solid
	state bodies, or methods related thereto,	state bodies, or methods related thereto, other
	other than those arrangements or methods	than those arrangements or methods covered
	covered by the following subgroups, are	by the following subgroups, are covered by
	covered by H01L 24/00	H01L 24/00.}
H01L23/544	When classifying in group H01L 23/544,	{When classifying in group H01L 23/544,
11011123/377	details are to be further indexed by using	details are to be further indexed by using the
	the indexing codes chosen from H01L	indexing codes chosen from H01L 2223/544
	2223/544 and subgroups	and subgroups.}
H01L23/66	When classifying in group H01L 23/66,	{When classifying in group H01L 23/66,
1101223700	details are to be further indexed by using	details are to be further indexed by using the
	the indexing codes chosen from H01L	indexing codes chosen from H01L 2223/66
	2223/66 and subgroups	and subgroups.}
H01L25/065	Group H01L25/0652 takes precedence over	{Group H01L25/0652 takes precedence over
11012207000	groups H01L25/0655 and H01L25/0657	groups H01L25/0655 and H01L25/0657.}
H01L25/07	Group H01L25/071 takes precedence over	{Group H01L25/071 takes precedence over
	groups H01L25/072 - H01L25/074	groups H01L25/072 - H01L25/074.}
H01L25/11	Group H01L25/112 takes precedence over	{Group H01L25/112 takes precedence over
1101220711	groups H01L25/115 and H01L25/117	groups H01L25/115 and H01L25/117.}
H01L25/105	When classifying in group H01L 25/105,	{When classifying in group H01L 25/105,
11012207100	details of the assemblies are to be further	details of the assemblies are to be further
	indexed by using the indexing codes chosen	indexed by using the indexing codes chosen
	from H01L 2225/1005 and subgroups	from H01L 2225/1005 and subgroups.}
H01L27/00	In this group the last place priority rule is	**This group in its entirety is being deleted in
	applied, i.e. at each hierarchical level, in the	RP12465; added here for
	absence of an indication to the contrary,	completion/reference purposes only.
	classification is made in the last appropriate	
	place.	
H03M 3/436	In this group branch the order of the loop	{In this group branch the order of the loop
	filters is considered to be the number of	filters is considered to be the number of
	integrators for a baseband modulator and	integrators for a baseband modulator and the
	the number of resonators for a bandpass	number of resonators for a bandpass
	modulator respectively	modulator respectively.}
H03M 3/44	In this subgroup, classification is made both	{In this subgroup, classification is made both
	here and in H03M 3/478 if both subgroups	here and in H03M 3/478 if both subgroups are
	are relevant	relevant.}
H03M 3/478	In this subgroup, classification is made both	{In this subgroup, classification is made both
	here and in H03M 3/44 if both subgroups	here <u>and</u> in H03M 3/44 if <u>both</u> subgroups are
	are relevant	relevant.}
		,

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Area	Current text	Proposed edit
H03M 5/00	1. In groups H03M 5/02 - H03M 5/22, in	In groups H03M 5/02 - H03M 5/22, the last
	the absence of an indication to the contrary,	place priority rule is applied, i.e. at each
	an invention is classified in the last	hierarchical level, in the absence of an
	appropriate place.	indication to the contrary, classification is
	2. {In this main group, additional	made in the last appropriate place.
	information has been classified	{This Note corresponds to IPC Note (1)
	systematically for documents published from 01-04-2004 onwards.}	relating to H03M5/02 - H03M5/22.}
H03M 7/00	In groups H03M7/001 - H03M7/50, the	In groups H03M7/02 - H03M7/30, the last
	last place priority rule is applied, i.e. at each	place priority rule is applied, i.e. at each
	hierarchical level, in the absence of an	hierarchical level, in the absence of an
	indication to the contrary, classification is	indication to the contrary, classification is
	made in the last appropriate place. 2. In	made in the last appropriate place.
	groups $H03M7/02 - H03M7/50$, in the	{This Note corresponds to IPC Note (1)
	absence of an indication to the contrary, an	relating to H03M7/02 - H03M7/30.}
	invention is classified in the last appropriate	
	place. 3. {In this main group, in the absence	
	of an indication to the contrary, additional	
	information has been classified	
	systematically for documents published from 01-04-2004 onwards.}	
H03M 7/3031	In this group the order of the loop filters is	{In this group the order of the loop filters is
	considered to be the number of integrators	considered to be the number of integrators for
	for a baseband modulator and the number of	a baseband modulator and the number of
	resonators for a bandpass modulator	resonators for a bandpass modulator
	respectively	respectively.}
H03M 13/2957	This group <u>covers</u> also aspects when a	{This group <u>covers</u> also aspects when a
	component code is replaced by a non-coded	component code is replaced by a non-coded
	constraint, e.g. like in joint turbo decoding	constraint, e.g. like in joint turbo decoding
*****	and detection	and detection.}
H03M 13/296	this group <u>covers</u> hybrid parallel and serial	{This group <u>covers</u> hybrid parallel and serial
	concatenated turbo code structures and	concatenated turbo code structures and other
	other unusual code structures that do not fit into H03M 13/2963 - H03M 13/2972	unusual code structures that do not fit into H03M 13/2963 - H03M 13/2972.}
H04J13/0007	Code type information should be classified	{Code type information should be classified
2 -2 -2,000,	in addition to other relevant a spects. This	in addition to other relevant a spects. This
	should also be done in cases where the other	should also be done in cases where the other
	relevant symbol refers to code type, e.g.	relevant symbol refers to code type, e.g. H04J
	H04J13/14, H04J13/20)	13/14, H04J 13/20)}
H04L 12/2856	1. This group <u>covers</u> :	{1. This group <u>covers</u> :
	access to a public data	access to a public data network, such
	network, such as an IP	as an IP network, for subscribers, i.e.
	network, for subscribers, i.e.	customers of a network service
	customers of a network	provider, over a wired network
	service provider, over a wired	 communication of generic types of
	network.	data between end-user equipments,
	 communication of generic 	located typically at the subscriber
	types of data between end-user	premises, and an access server,
	equipments, located typically	which acts as interface between the
	at the subscriber premises, and	

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Area	Current text	Proposed edit
Area	an access server, which acts as interface between the access network and the public data network. 2. This group does not cover: • wireless access networks, which are covered by H04W • optical distribution networks, which are covered by H04Q 11/0067 • bit-level, or PHY layer, processing of data between digital subscriber line equipments, which is covered by H04M 11/06 • design of DSL, digital subscriber line, modems, which is covered by H04M 11/06 • exchange of data related to functionalities of home network appliances between a home network and an external network, which is covered by H04L 12/2803 • management of WDM parameters in optical multiplex systems, which is covered by H04J 14/02 • circuit-switched access networks, which are covered by H04M7/1205 • access arrangements for providing telephone service in networks other than PSTN/ISDN, which are covered by H04M7/0066 3. In this group the following terms or expressions are used with the meaning indicated: • ATM means Asynchronous Transfer Mode • LAN means Local Area Network	access network and the public data network } {2. This group does not cover: • wireless access networks, which are covered by H04W • optical distribution networks, which are covered by H04Q 1 1/0067 • bit-level, or PHY layer, processing of data between digital subscriber line equipments, which is covered by H04M 11/06 • design of DSL, digital subscriber line, modems, which is covered by H04M 11/06 • exchange of data related to functionalities of home network appliances between a home network and an external network, which is covered by H04L 12/2803 • management of WDM parameters in optical multiplex systems, which is covered by H04J 14/02 • circuit-switched access networks, which are covered by H04M 7/1205 • access arrangements for providing telephone service in networks other than PSTN/ISDN, which are covered by H04M 7/0066} {3. In this group the following terms or expressions are used with the meaning indicated: • ATM means Asynchronous Transfer Mode • LAN means Local Area Network • BRAS means Broadband Remote Access Server • DSLAM means Digital Subscriber Line Access Multiplexer • MSAN means Digital Subscriber Line Access Node • DSL means Digital Subscriber Line IP means Internet Protocol • WDM means Wavelength Division Multiplexing
		WDM means Wavelength Division

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Area	Current text	Proposed edit
	 MSAN means MultiService Access Node DSL means Digital Subscriber Line IP means Internet Protocol WDM means Wavelength Division Multiplexing SDH means Synchronous Digital Hierarchy OTN means Optical Transport Network PSTN means Public Switched Telephone Network ISDN means Integrated Services Digital Network TDM means Time-Division Multiplexing TDMA means Time Division Multiple Access 	 PSTN means Public Switched Telephone Network ISDN means Integrated Services Digital Network TDM means Time-Division Multiplexing TDMA means Time Division Multiple Access}
H04L12/40006	In this group the following terms or expressions are used with the meaning indicated: • a bus controller is a microprocessor dedicated to input and output of data by a node on a bus; • a bus master is a device controlling which node accesses the bus at a particular time; • a bus guardian is a device monitoring the timing of node accesses on the bus; • a bus interface enhancer is a hardware or software a rrangement managing the bus controller or the bus interface to modify its behaviour or providing a transparent interface to the bus controller	 {In this group the following terms or expressions are used with the meaning indicated: a bus controller is a microprocessor dedicated to input and output of data by a node on a bus; a bus master is a device controlling which node accesses the bus at a particular time; a bus guardian is a device monitoring the timing of node accesses on the bus; a bus interface enhancer is a hardware or software arrangement managing the bus controller or the bus interface to modify its behaviour or providing a transparent interface to the bus controller.}
H04L 2012/40208	In this group the following terms or expressions are used with the meaning indicated: • Controller-area network (CAN or CAN-bus) designates a computer network protocol and bus standard developed in 1983 by Intel Corporation and Robert Bosch GmbH to allow microcontrollers and devices	{In this group the following terms or expressions are used with the meaning indicated: • Controller-area network (CAN or CAN-bus) designates a computer network protocol and bus standard developed in 1983 by Intel Corporation and Robert Bosch GmbH to a llow microcontrollers and devices to communicate with each other without a host computer;

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Area	Current text	Proposed edit
	to communicate with each other without a host computer; PROFIBUS (Process Field Bus) designates a standard for field bus communication in automation technology first implemented in 1989 by BMBF, the german department of education and research; Modbus designates a serial communications protocol published by Modicon in 1979 for use with its programmable logic controller; LIN-Bus (Local Interconnect Network) designates a computer networking bussystem released in 1999 used within current automotive network architectures; FlexRay designates an automotive network communications protocol developed by the FlexRay Consortium; LON or Lon Works designates a network standard operating on twisted pair or electrical wiring or coaxial cable and used for building automation; ASI or AS-Interface (Actuator Sensor Interface) designates the simplest of the industrial networking protocols used in programmable logic controller	 PROFIBUS (Process Field Bus) designates a standard for field bus communication in automation technology first implemented in 1989 by BMBF, the German Department of Education and Research; Modbus designates a serial communications protocol published by Modicon in 1979 for use with its programmable logic controller; LIN-Bus (Local Interconnect Network) designates a computer networking bus-system released in 1999 used within current automotive network architectures; FlexRay designates an automotive network communications protocol developed by the FlexRay Consortium; LON or LonWorks designates a network standard operating on twisted pair or electrical wiring or coaxial cable and used for building automation; ASI or AS-Interface (Actuator Sensor Interface) designates the simplest of the industrial networking protocols used in programmable logic controller systems}
H04L 25/03171	systems This group contains provisionally all documents which deal with turbo equalisation	{This group contains provisionally all documents which deal with turbo equalisation.}
H04L 25/03248	This group <u>covers</u> a rrangements in which the sequence estimator is specially adapted to provide signals to, or receive signals from, the other apparatus. The group <u>does not cover</u> the mere juxtaposition of elements	{This group <u>covers</u> arrangements in which the sequence estimator is specially adapted to provide signals to, or receive signals from, the other apparatus. The group <u>does not cover</u> the mere juxtaposition of elements.}
H04R 1/10	 This group covers details of headphones, both of monophonic and stereophonic type. When classifying in this group or in its subgroups, a spects relating to stereophonic 	{1. This group covers details of headphones, both of monophonic and stereophonic type.} {2. When classifying in this group or in its subgroups, a spects relating to stereophonic

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Area	Current text	Proposed edit
	headphones are to be classified in H04R	headphones are to be classified in H04R 5/033
	5/033 as well	as well.}
H04R 25/00	Classification should be directed to groups	{Classification should be directed to groups
	H04R 25/02, H04R 25/04 or H04R 25/50	H04R 25/02, H04R 25/04 or H04R 25/50 and
	and its subgroups, if and only if the	its subgroups, if and only if the technical
	technical subject in consideration cannot be	subject in consideration cannot be classified
	classified elsewhere under the main group	elsewhere under the main group H04R
	H04R 25/00	25/00.}
H04R 25/65	Housing parts for mechanical mounting or	{Housing parts for mechanical mounting or
	interconnection of hearing aid parts covered	interconnection of hearing aid parts covered
	by H04R 25/60 are to be classified in H04R	by H04R 25/60 are to be classified in H04R
	25/60	25/60.}
G06Q20/202	Features of the apparatus <u>per se</u> should be	{Features of the apparatus per se should be
	classified in G07G 1/14	classified in G07G 1/14.}
G06Q20/387	This group <u>covers</u> only the usage of	{This group <u>covers</u> only the usage of
	discounts or coupons interacting with the	discounts or coupons interacting with the
	payment of the protocol	payment of the protocol.}
G06Q30/0284	Constructional a spects of time meters are	{Constructional a spects of time meters are
	classified in groups G07B 13/00, G07B	classified in groups G07B 13/00, G07B 15/00
	15/00 or G07F 17/24	or G07F 17/24.}
G07B 17/00733	References listed below indicate CPC	{References listed below indicate CPC places
	places which could also be of interest when	which could also be of interest when carrying
	carrying out a search in respect of the	out a search in respect of the subject matter
	subject matter covered by the preceding	covered by the preceding group:
	group:	secret or secure communication
	secret or secure communication	H04L 9/00
	H04L 9/00	 mechanisms actuated by objects
	mechanisms actuated by objects	other thancoins to free or to a ctuate
	other thancoins to free or to actuate	vending, hiring, coin or paper
	vending, hiring, coin or paper	currency dispensing or refunding
	currency dispensing or refunding	apparatus for cashless transactions
	apparatus for cashless transactions	only G07F7/10
	only G07F7/10	• access-control involving the use of a
	 access-control involving the use of 	pass in combination with an identity-
	a pass in combination with an	check of the pass-holder by means
	identity-check of the pass-holder	of personal physical data, e.g.
	by means of personal physical	characteristic facial curves, hand
	data, e.g. characteristic facial	geometry, voice spectrum,
	curves, hand geometry, voice	fingerprints G07C9/00
	spectrum, fingerprints G07C 9/00	• recognising characters or patterns in
	 recognising characters or patterns 	general G06F 18/00, G06V 30/00
	in general G06F 18/00, G06V	l
	30/00	• random or pseudo-random generators G06F7/58
	random or pseudo-random	
	generators G06F7/58	circuits generating pulses having a
		predetermined statistical distribution
	• circuits generating pulses having a	H03K3/84
	predetermined statistical	multiple service credit cards with
	distribution H03K 3/84	protecting memory zones G07F7/10

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Area	Current text	Proposed edit
	 multiple service credit cards with protecting memory zones G07F 7/10 security arrangements for protecting computers or computer systems against unauthorised activity G06F 21/00 record carriers with conductive marks and special arrangements for circuits, e.g. for protecting identification code in memory G06K 19/073 error detection and error correction G06F 11/00 coding, decoding or code conversion, for error detection or error correction H03M 13/00 	 security arrangements for protecting computers or computer systems against unauthorised activity G06F 21/00 record carriers with conductive marks and special arrangements for circuits, e.g. for protecting identification code in memory G06K 19/073 error detection and error correction G06F 11/00 coding, decoding or code conversion, for error detection or error correction H03M 13/00.}